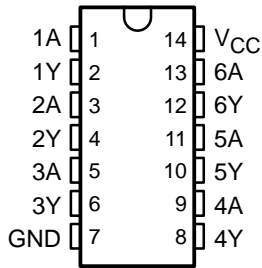


SN54AHCT14, SN74AHCT14 HEX SCHMITT-TRIGGER INVERTERS

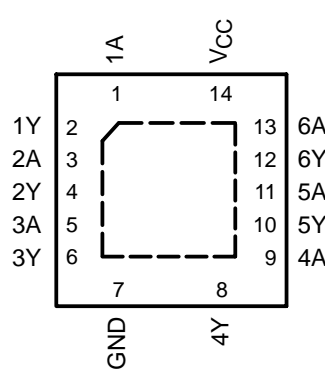
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- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

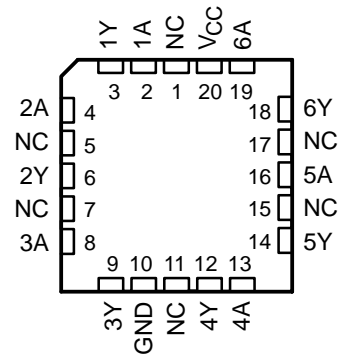
SN54AHCT14 . . . J OR W PACKAGE
SN74AHCT14 . . . D, DB, DGV, N, NS,
OR PW PACKAGE
(TOP VIEW)



SN74AHCT14 . . . RGY PACKAGE
(TOP VIEW)



SN54AHCT14 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The 'AHCT14 devices contain six independent inverters. These devices perform the Boolean function $Y = \bar{A}$. Each circuit functions as an independent inverter, but because of the Schmitt action, the inverters have different input threshold levels for positive-going (V_{T+}) and for negative-going (V_{T-}) signals.

ORDERING INFORMATION

| TA | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|---------------|-----------------------|------------------|
| –40°C to 85°C | QFN – RGY | Tape and reel | SN74AHCT14RGYR | HB14 |
| | PDIP – N | Tube | SN74AHCT14N | SN74AHCT14N |
| | SOIC – D | Tube | SN74AHCT14D | AHCT14 |
| | | Tape and reel | SN74AHCT14DR | |
| | SOP – NS | Tape and reel | SN74AHCT14NSR | AHCT14 |
| | SSOP – DB | Tape and reel | SN74AHCT14DBR | HB14 |
| | TSSOP – PW | Tube | SN74AHCT14PW | HB14 |
| Tape and reel | | SN74AHCT14PWR | | |
| –55°C to 125°C | TVSOP – DGV | Tape and reel | SN74AHCT14DGVR | HB14 |
| | CDIP – J | Tube | SNJ54AHCT14J | SNJ54AHCT14J |
| | CFP – W | Tube | SNJ54AHCT14W | SNJ54AHCT14W |
| | LCCC – FK | Tube | SNJ54AHCT14FK | SNJ54AHCT14FK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

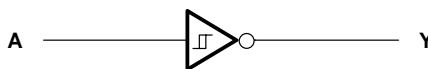
SN54AHCT14, SN74AHCT14 HEX SCHMITT-TRIGGER INVERTERS

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FUNCTION TABLE
(each inverter)

| INPUT A | OUTPUT Y |
|------------|-------------|
| H | L |
| L | H |

logic diagram, each inverter (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to 7 V |
| Output voltage range, V_O (see Note 1) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ± 20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ± 25 mA |
| Continuous current through V_{CC} or GND | ± 50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): D package | 86°C/W |
| (see Note 2): DB package | 96°C/W |
| (see Note 2): DGV package | 127°C/W |
| (see Note 2): N package | 80°C/W |
| (see Note 2): NS package | 76°C/W |
| (see Note 2): PW package | 113°C/W |
| (see Note 3): RGY package | 47°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
3. The package thermal impedance is calculated in accordance with JESD 51-5.

recommended operating conditions (see Note 4)

| | SN54AHCT14 | | SN74AHCT14 | | UNIT |
|--------------------------------------|------------|----------|------------|----------|------|
| | MIN | MAX | MIN | MAX | |
| V_{CC} Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V_I Input voltage | 0 | 5.5 | 0 | 5.5 | V |
| V_O Output voltage | 0 | V_{CC} | 0 | V_{CC} | V |
| I_{OH} High-level output current | | -8 | | -8 | mA |
| I_{OL} Low-level output current | | 8 | | 8 | mA |
| T_A Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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SN54AHCT14, SN74AHCT14 HEX SCHMITT-TRIGGER INVERTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | | SN54AHCT14 | | SN74AHCT14 | | UNIT |
|---|---|-----------------|-----------------------|-----|------|------------|------|------------|------|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{T+} Positive-going input threshold voltage | | 4.5 V | 0.9 | | 1.9 | 0.9 | 1.9 | 0.9 | 1.9 | V |
| | | 5.5 V | 1 | | 2.1 | 1 | 2.1 | 1 | 2.1 | |
| V _{T-} Negative-going input threshold voltage | | 4.5 V | 0.5 | | 1.5 | 0.5 | 1.5 | 0.5 | 1.5 | V |
| | | 5.5 V | 0.6 | | 1.7 | 0.6 | 1.7 | 0.6 | 1.7 | |
| ΔV _T Hysteresis (V _{T+} - V _{T-}) | | 4.5 V | 0.4 | | 1.4 | 0.4 | 1.4 | 0.4 | 1.4 | V |
| | | 5.5 V | 0.4 | | 1.5 | 0.4 | 1.5 | 0.4 | 1.5 | |
| V _{OH} | I _{OH} = -50 μA | 4.5 V | 4.4 | 4.5 | | 4.4 | | 4.4 | | V |
| | I _{OH} = -8 mA | 4.5 V | 3.94 | | | 3.8 | | 3.8 | | |
| V _{OL} | I _{OL} = 50 μA | 4.5 V | | | 0.1 | | 0.1 | | 0.1 | V |
| | I _{OL} = 8 mA | 4.5 V | | | 0.36 | | 0.44 | | 0.44 | |
| I _I | V _I = 5.5 V or GND | 0 V to 5.5 V | | | | ±0.1 | | ±1* | | μA |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | | 2 | | 20 | | μA |
| ΔI _{CC} † | One input at 3.4 V, Other inputs at V _{CC} or GND | 5.5 V | | | | 1.35 | | 1.5 | | mA |
| C _i | V _I = V _{CC} or GND | 5 V | | 2 | 10 | | | | 10 | pF |

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

† This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | T _A = 25°C | | | SN54AHCT14 | | SN74AHCT14 | | UNIT |
|------------------|-----------------|----------------|------------------------|-----------------------|-----|-----|------------|-----|------------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | A | Y | C _L = 15 pF | | 4** | 7** | 1** | 8** | 1 | 8 | ns |
| t _{PHL} | | | | | 4** | 7** | 1** | 8** | 1 | 8 | |
| t _{PLH} | A | Y | C _L = 50 pF | | 5.5 | 8 | 1 | 9 | 1 | 9 | ns |
| t _{PHL} | | | | | 5.5 | 8 | 1 | 9 | 1 | 9 | |

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 5)

| PARAMETER | | SN74AHCT14 | | | UNIT |
|--------------------|---|------------|------|-----|------|
| | | MIN | TYP | MAX | |
| V _{OL(P)} | Quiet output, maximum dynamic V _{OL} | | 0.9 | | V |
| V _{OL(V)} | Quiet output, minimum dynamic V _{OL} | | -0.7 | | V |
| V _{OH(V)} | Quiet output, minimum dynamic V _{OH} | | 4.3 | | V |
| V _{IH(D)} | High-level dynamic input voltage | | 2.1 | | V |
| V _{IL(D)} | Low-level dynamic input voltage | | | 0.5 | V |

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, V_{CC} = 5 V, T_A = 25°C

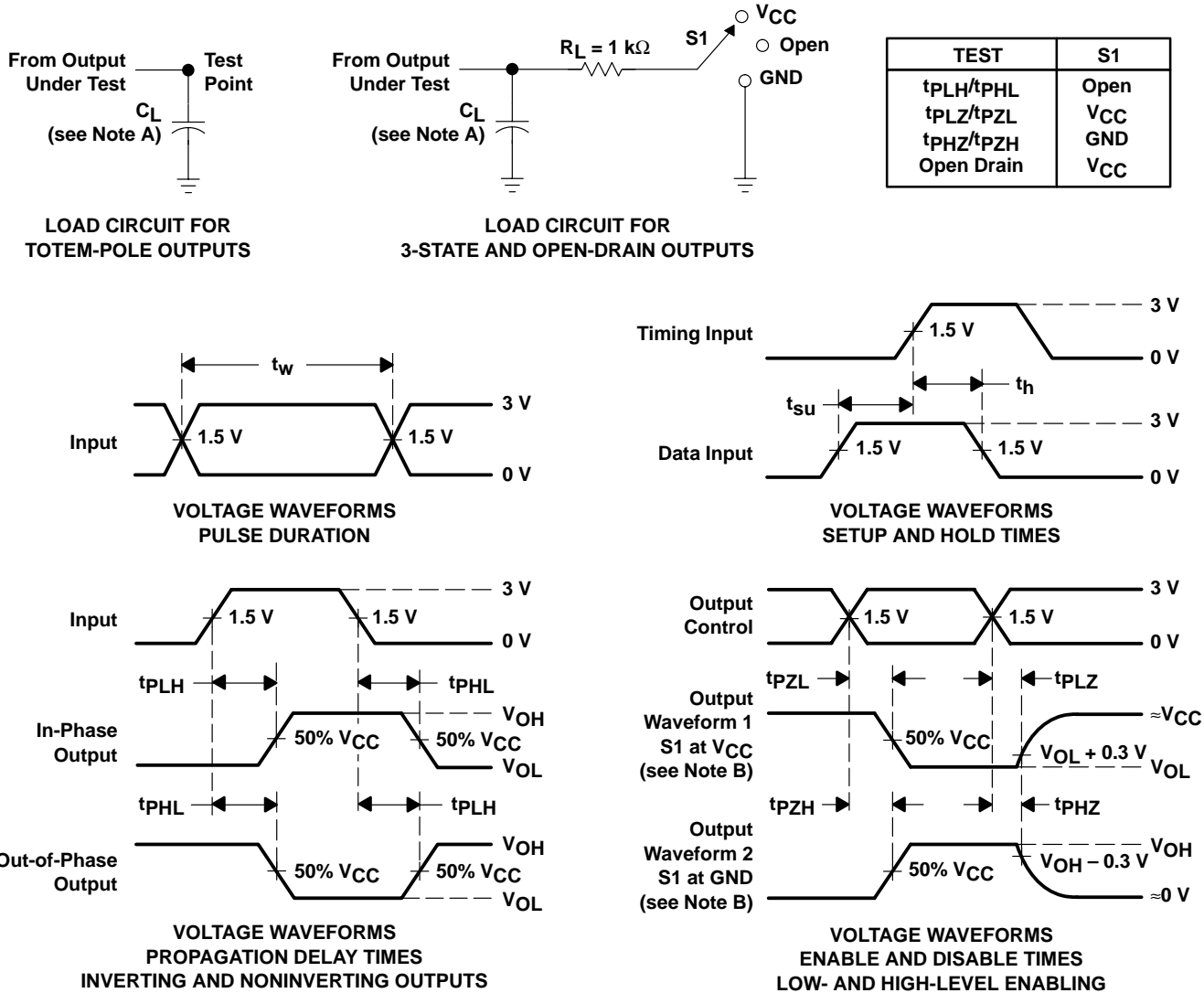
| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|---|--------------------|-----|------|
| C _{pd} Power dissipation capacitance | No load, f = 1 MHz | 12 | pF |



SN54AHCT14, SN74AHCT14 HEX SCHMITT-TRIGGER INVERTERS

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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 3 ns, t_f ≤ 3 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |

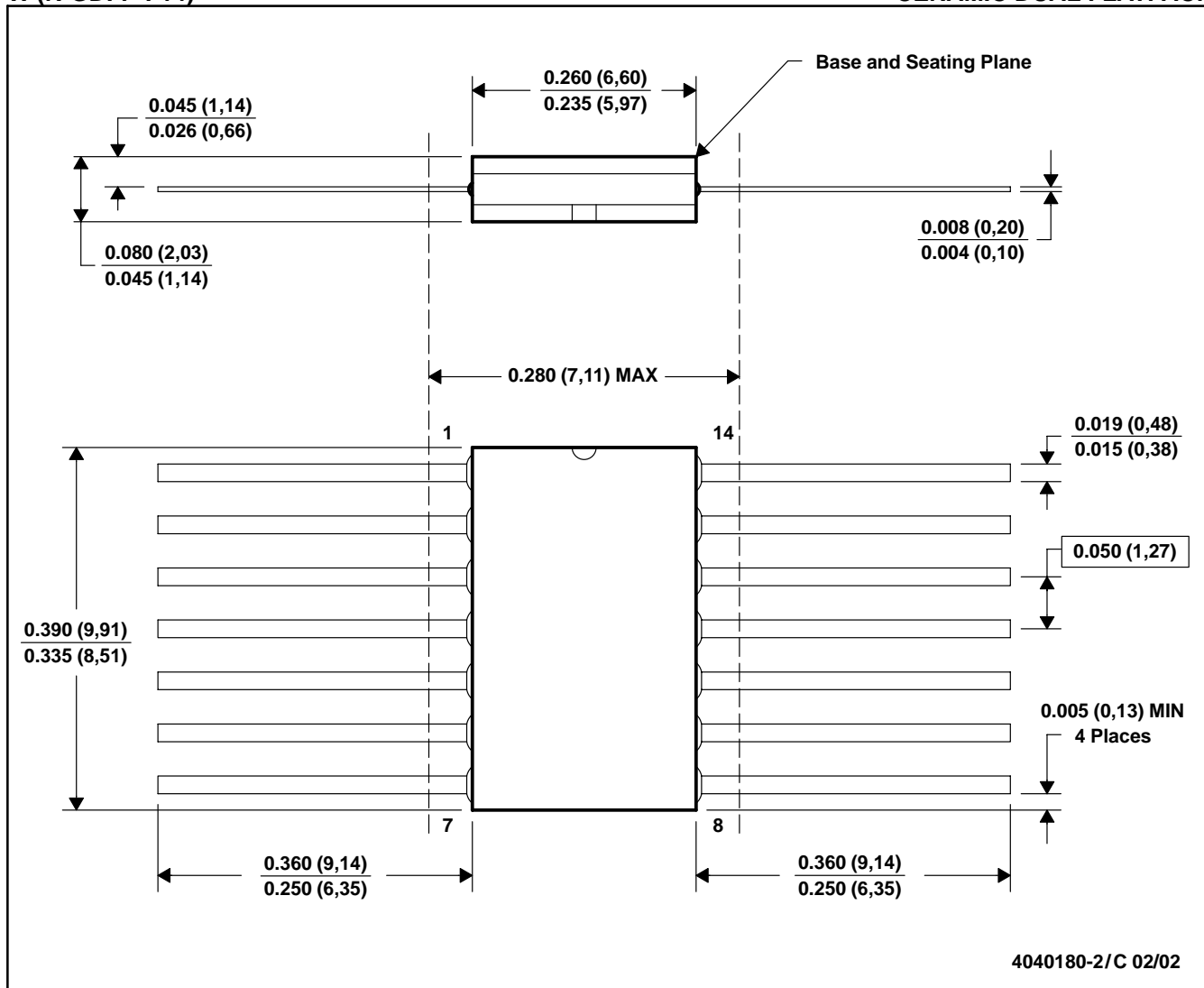


4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

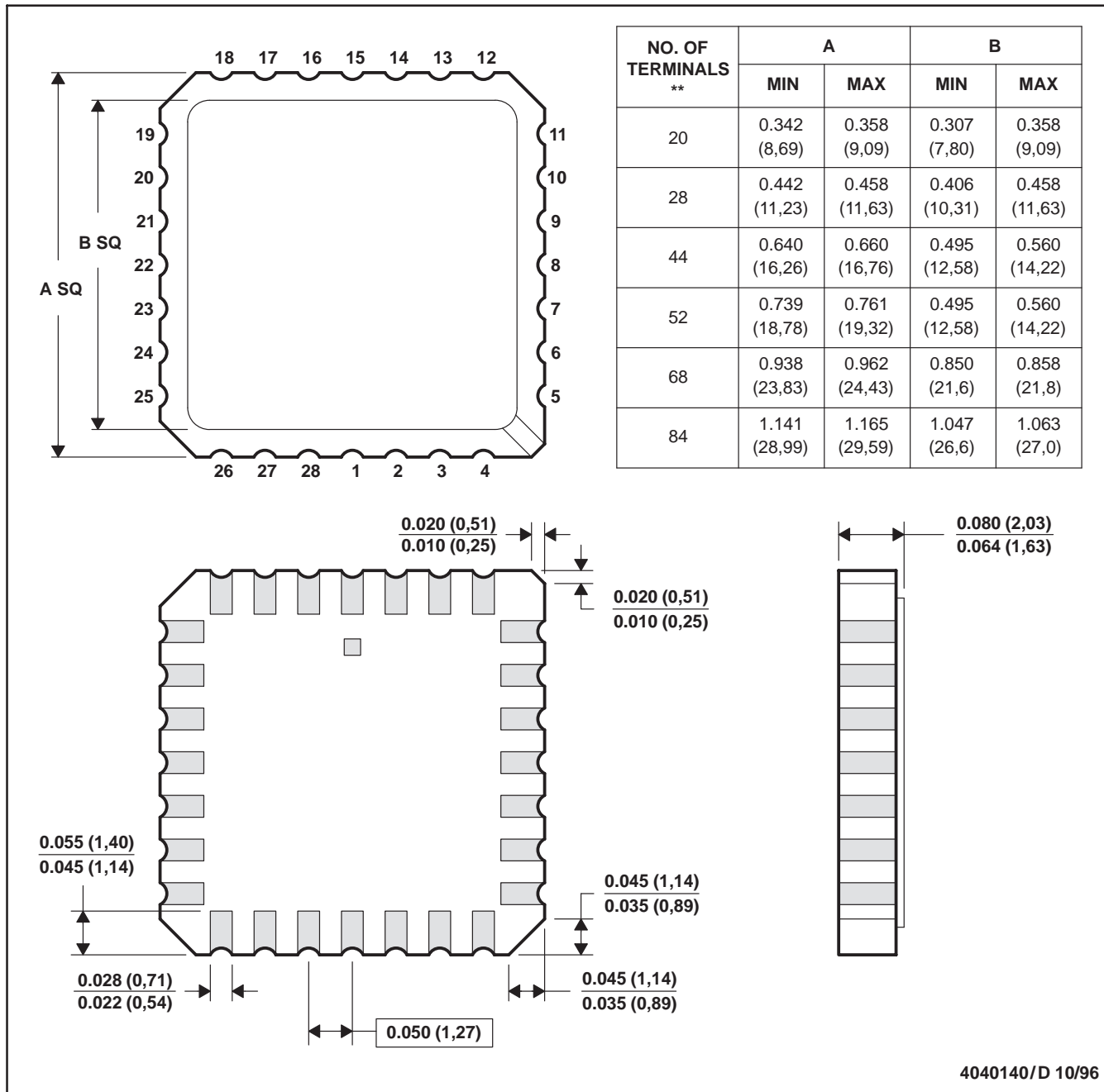


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification only.
 E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

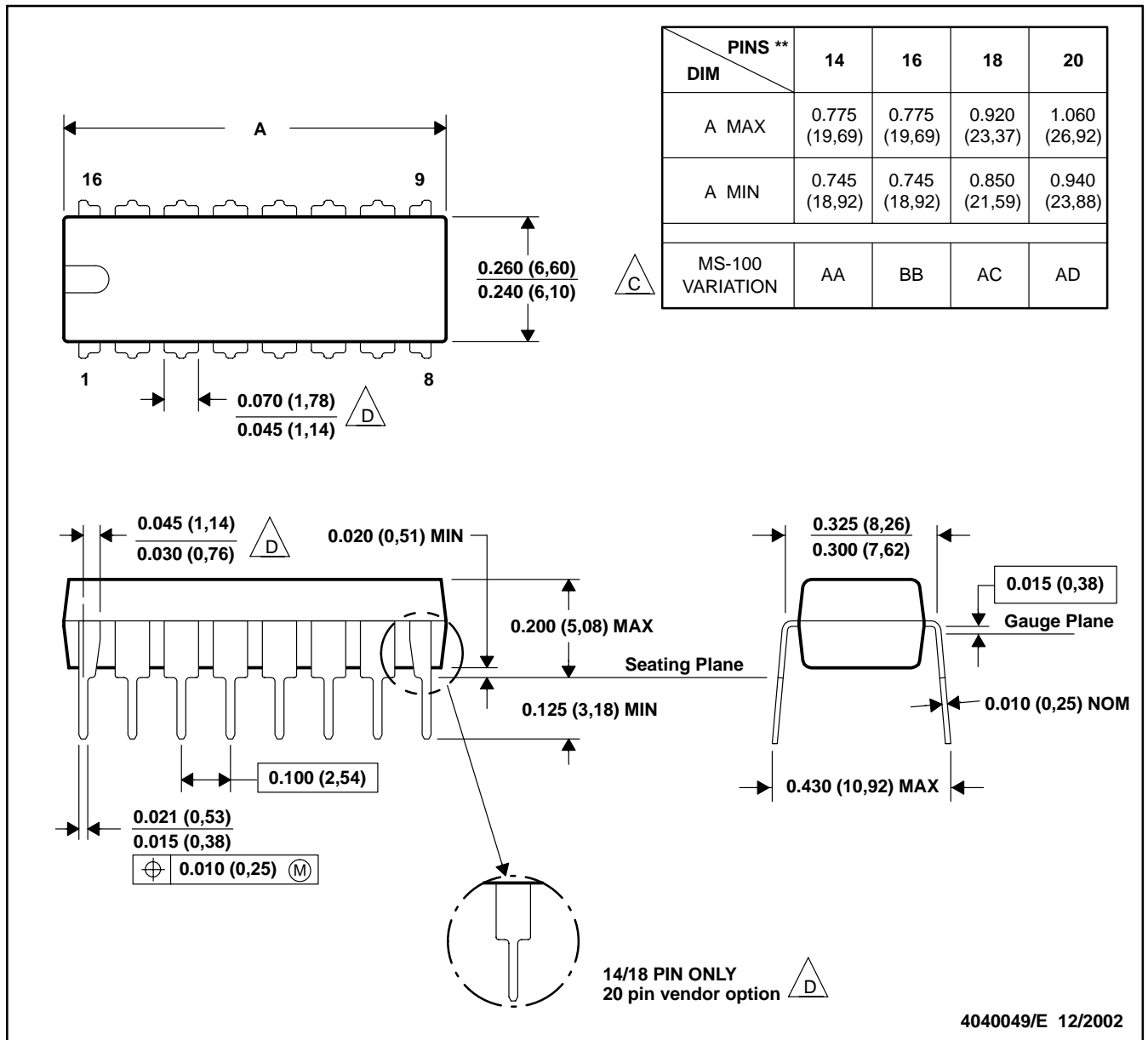


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

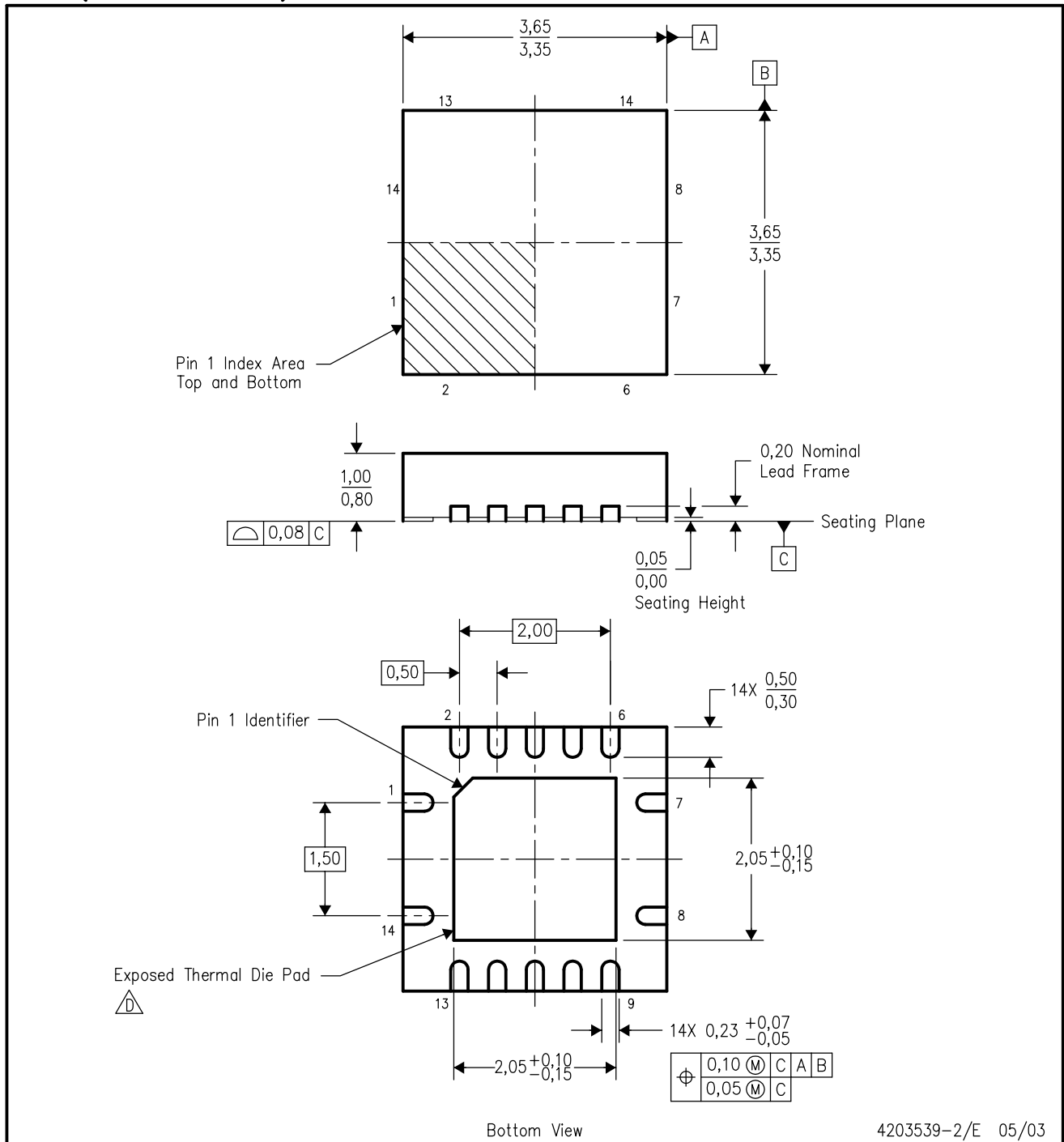
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

RGY (S-PQFP-N14)

PLASTIC QUAD FLATPACK

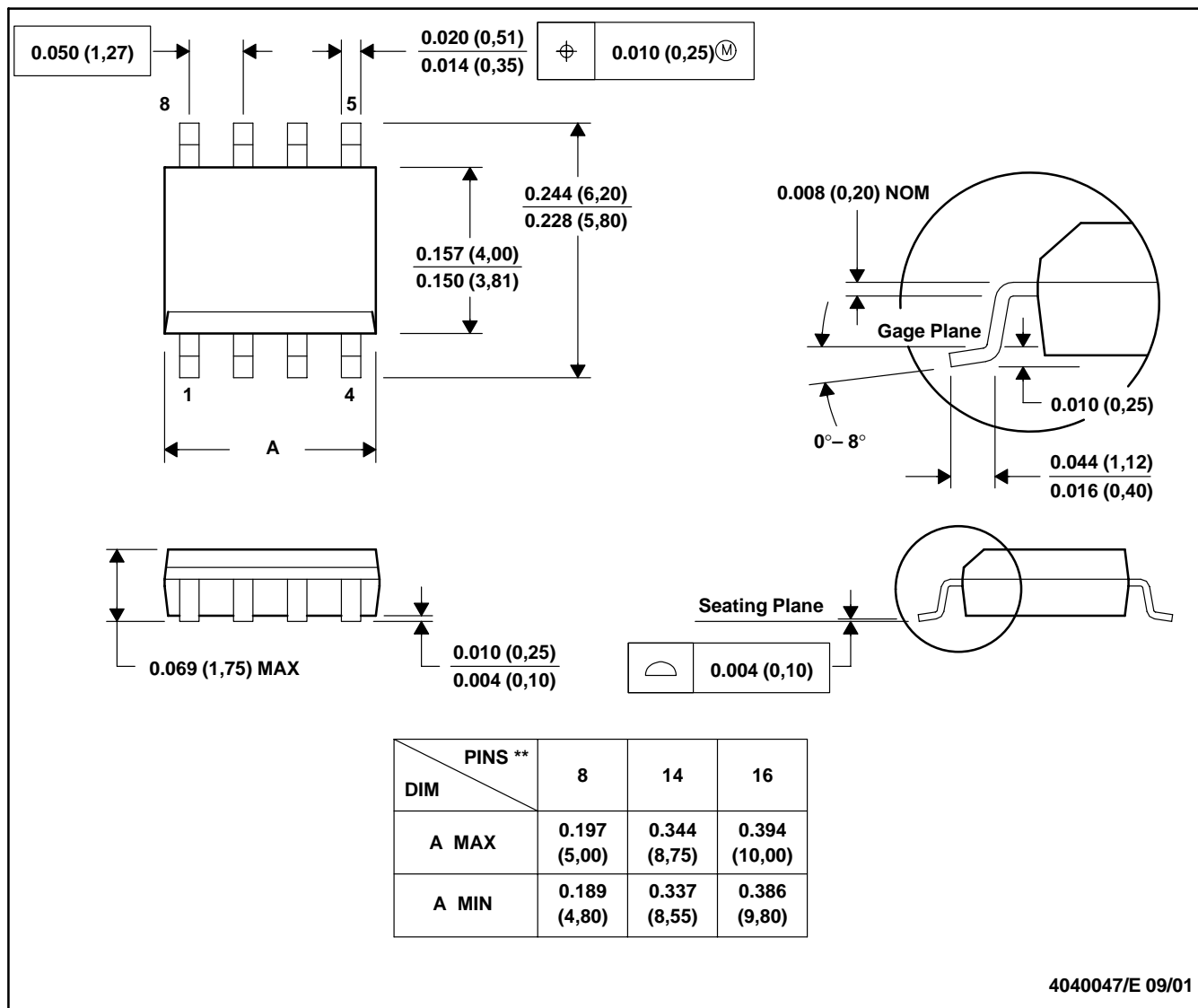


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - D. The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BA.

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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